

LEDTECH ELECTRONICS CORP.

(Zone 22) North Guiyuan Rd., West Jixi Rd., Duanzhou District, Zhaoqing City, Guangdong Province, China TEL:86-758-2877017,2875541,2870651,2877464 FAX:86-758-2878014 <u>Http://www.ledtech.com.tw</u>

SPECIFICATION

PART NO. : LP30NR-S895 13.5W COB 19*19mm TYPE





Features

- Pb-Free soldering application
- I RoHS compliance
- I Multi-Chip package
- I High Reliability

Application

- Bay-light module
- I Indoor decorative lighting
- I Illumination
- Automotive Application
- Architectural Lighting
- I Indicator / Decoration



+Vcc

Package Dimensions



15S / 2P

GND

Notes:

- 1. All dimensions are in mm.
- 2. Tolerance is ± 0.5 mm unless otherwise noted.

Description

	LED Ch		
Part No.	Material	Emitting Color	Lens Color
LP30NR-S895	InGaN/Sapphire	Neutral White	Yellow Diffused



Absolute Maximum Ratings at Ta=25 °C

Parameter	Symbol	Rating	Unit
Power Dissipation	Pd	13.5	W
D.C. Forward Current	If	300	mA
LED Junction Temperature	Tj	150	°C
Operating Temperature Range	Topr.	-40 to +110	°C
Storage Temperature Range	Tstg.	-40 to +120	°C
Solder Heat Resistance	SHR	Hand Soldering:260±5°C for 10 sec.	
Electric Static Discharge Threshold (HBM)	ESD	1000	V

Electrical and Optical Characteristics:

Donomotor	Symphol	Condition	Values			T T *4
rarameter	Symbol		Min.	Тур.	Max.	Units
Luminous Flux	Φv	IF=300mA	1300	1400	1500	lm
Forward voltage	VF	IF=300mA		43		v
Forward voltage			41		45	
Efficiency	η	IF=300mA	95	110	-	lm/W
Correlated Color Temperature	ССТ	IF=300mA	2950		3150	
CIE Chromaticity Coordinates: X Axis	X	IF=300mA		0.4386		
CIE Chromaticity Coordinates: Y Axis	Y	IF=300mA		0.4120		
Reverse Current	I _R	Vr=48V			50	μΑ
Color Rendering Index	CRI	IF=300mA		95		Ra
Viewing angle at 50% IV		201/2		120		Deg.

Notes: 1.Tolerance of Luminous Intensity is $\pm 15\%$

2.Tolerance of Forward Voltage is ±0.1V

3.Tolerance of Correlated Colour Temperature is $\pm 5\%$ 4.Tolerance of Color Rendering Index is ± 2



Chromaticity Coordinates Specifications for Bin Grading:

COLOR RANKS (IF=300mA.Ta=25°C)
-------------------------------	---

BIN	RANK					
7B-2	Х	0.4281	0.4359	0.443	0.4342	
	Y	0.4006	0.4187	0.4212	0.4028	
7C-1	Х	0.4342	0.443	0.4496	0.4403	
	Y	0.4028	0.4212	0.4236	0.4049	

Note: X.Y Tolerance each Bin limit is±0.01.

Chromaticity Coordinates & Bin grading diagram:







Ambient Temperature VS. Forward Current

Radiation Diagram



Sulfur-sensitive

- I There is silver-plated metal part on the inner/outer side of the outer package.
 - If exposed to the condition with corrosive gas, the silver plating surface may go bad, which will affect soldering strength and optical properties. Therefore, after opening it must be kept in a sealed container, etc.
- I Materials contain sulfur component (gasket, adhesive, etc.) may have bad effects on the surface of the coating, so please do not use such materials in the product.
- I In cardboard boxes and rubber, even in the atmosphere may contain minute amount of corrosive gases; In addition, the resin material may also contain halogen which has a bad effect on the surface of the coating.
- I Even if the soldering installation and product assembly finished, by the effect of corrosive gas generated by relative materials of LED and external injected, the coating surface may go bad, so it is necessary to design the product taking into account the above factors.
- I If requires, it is best to use a silicone washer, but be aware that low molecular silicone may cause the product poor contact.
- Keep the product in location where has less temperature change, because moisture condensation would be generated under a condition of strong temperature change.

DISCLAIMER

- **1.** Our department reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets our department published specification for a period of twelve (12) months from date of shipment.
- **3.**The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4.When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. Our department assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 5. These specification sheets include materials protected under copyright of our department. Reproduction in any form is prohibited without obtaining our department's prior consent.
- 6.This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or life saving applications or any other application which can result in human injury or death. Please contact authorized our department sales agent for special application request.



Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound



Figure 1

In general, LEDs should only be handled from the side. By the way, this also applies to LEDs without a silicone sealant, since the surface can also become scratched.



Figure 2

When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented. This is assured by choosing a pick and place nozzle which is larger than the LED's reflector area.



